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Features

- Very Low-cost Configuration Memory
- Programmable 1,048,576 x 1, 2,097,152 x 1, 4,194,304 x 1 and 7,340,032 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- 1.8V, 2.5V, and 3.3V I/O
- 3.3V Supply Voltage
- Program Support using an Atmel Programmer or Industry-standard Third Party Programmers
- In-System Programmable (ISP) via JTAG Interface (IEEE 1532)
- IEEE 1149.1 Boundary-scan Testability
- Simple Interface to SRAM FPGAs
- Pin Compatible with Xilinx[®] XCFxxS Series Platform Flash PROM to Configure Xilinx Spartan[®] and Virtex[®] FPGAs
- Cascadable Read-back to Support Additional Configurations or Higher-density FPGAs
- Low-power CMOS FLASH Process
- Available in 20-lead TSSOP Package
- Low-power Standby Mode
- Fast Serial Download Speeds up to 33 MHz
- Endurance: 100,000 Write Cycles Typical
- Green (Pb/Halide-free/RoHS Compliant) Package
- Functionally-compatible with Existing AT17 Series Configuration Memories to Configure Atmel AT40KAL Series FPGAs

AT18F Series Configuration Memory Offering

	AT18F010	AT18F002	AT18F040	AT18F080			
Density	1 Mbit	2 Mbit	4 Mbit	7 Mbit			
JTAG Programming	Yes						
VCCINT	3.3V						
VCCO	1.8-3.3V						
VCCJ	1.8-3.3V						
Configuration Clock	33 MHz						
Package	20-lead TSSOP						
Green Package	Yes						

1. Description

The AT18F Series of JTAG In-System Programmable Configuration PROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for Field Programmable Gate Arrays. The AT18F Series device is packaged in a 20-lead TSSOP. The AT18F Series Configurator uses a simple serial-access procedure to configure one or more FPGA devices.

The AT18F Series Configurators can be programmed with Atmel or industry-standard, third-party, stand-alone programmers such as BP, Data I/O, Hi-Lo, etc.



FPGA Configuration Flash Memory

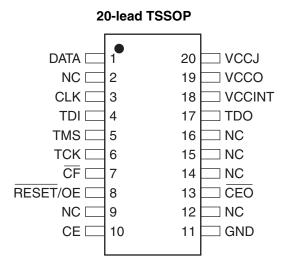
AT18F010 AT18F002 AT18F040 AT18F080

Preliminary

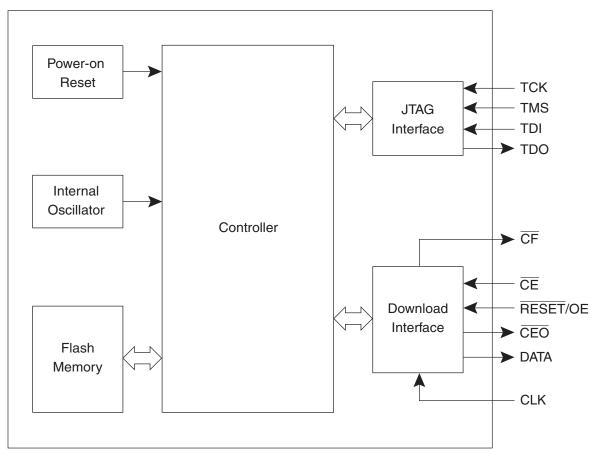




2. Pin Configuration



3. Block Diagram



2 AT18F010/002/040/080 [Preliminary]

4. Device Description

The download interface of the configuration memory will directly communicate with the FPGA through the interface-control signals (CLK, RESET/OE, CE) to initialize and terminate configuration. All FPGA devices in the master serial mode can control the entire configuration process to receive data from the configuration device without requiring an external intelligent controller. When FPGA devices are used in slave serial mode, an external clock signal can be applied to the CLK pin of an AT18F series device as a configuration loading clock. Multiple FPGAs that are setup in Master Serial and Slave Serial modes can also be used to control the configuration process to obtain data from a single configurator or cascaded configurators. Please contact Atmel at configurator@atmel.com for detailed descriptions.

The \overline{CF} pin is used as an optional input pin for the JTAG CONFIG instruction to initialize the FPGA configuration without requiring powering down the device. The \overline{RESET}/OE and \overline{CE} pins control the tri-state buffer on the DATA output pin and enable the address counter. When \overline{RESET}/OE is driven Low, the configuration device resets its address counter and tri-states its DATA pin. The \overline{CE} pin also controls the output of the AT18F Series Configurator. If \overline{CE} is held High after the \overline{RESET}/OE reset pulse, the counter is reset and the DATA output pin is tri-stated.

When the configurator has driven out all of its data and \overline{CEO} is driven Low, the device tri-states the DATA pin to avoid contention with other configurators. Upon power-up, the address counter is automatically reset.





AT18F series devices are compatible with a portion of the Xilinx's FGPA device families.

Atmel	Xilinx Atmel		Xili	Xilinx	
	Martana II	XC2V40		Virtex-II Pro	XC2VP4
	Virtex-II	XC2V80		<u>хе</u> . н	XC2V500
		XCV50E		Virtex-II	XC2V1000
	Virtex-E	XCV100E			XCV400E
		XCV50		Virtex-E	XCV405E
	Virtex	XCV100			XCV600E
		XCV150			XCV400
	Spartan-3E	XC3S100E	AT18F040-30XU	Virtex	XCV600
AT18F010-30XU		XC3S50		0 1 05	XC3S500E
	Spartan-3	XC3S200		Spartan-3E	XC3S1200E
	o	XC2S50E		Spartan-3L	XC3S1000L
	Spartan-IIE	XC2S100E		Spartan-3	XC3S1000
	Spartan-II	XC2S15		o	XC2S400E
		XC2S30		Spartan-IIE	XC2S600E
		XC2S50		Virtex-5 LX	XC5VLX30
		XC2S100		Virtex-4 LX	XC4VLX15
		XC2S150			XC4VLX25
	Virtex-II Pro	XC2VP2			XC4VFX12
	Virtex-II	XC2V250		Virtex-4 FX	XC4VFX20
		XCV200E		Virtex-II Pro X	XC2VPX20
	Virtex-E	XCV300E			XC2VP7
	. <i></i> .	XCV200		Virtex-II Pro	XC2VP20
	Virtex	XCV300		N.C. 11	XC2V1500
AT18F002-30XU	Spartan-3E	XC3S250E	AT18F080-30XU	Virtex-II	XC2V2000
	Spartan-3	XC3S400			XCV812E
		XC2S150E		Virtex-E	XCV1000E
	Spartan-IIE	XC2S200E			XCV1600E
		XC2S300E		\ <i>r</i> .	XCV800
	Spartan-II	XC2S200		Virtex	XCV1000
		<u> </u>		Spartan-3E	XC3S1600E
				Spartan-3L	XC3S1500L
				On antas a	XC3S1500
				Spartan-3	XC3S2000
			L		

 Table 4-1.
 AT18F Series Configurator Compatibility with Xilinx FPGAs

5. Programming

AT18Fxx devices are in-system programmable (ISP) devices utilizing the 4-pin JTAG protocol. This capability eliminates package handling normally required for programming and facilitates rapid design iterations and field changes.

Atmel provides ISP hardware and software to allow programming of the AT18Fxx via the PC. ISP is performed by using either a download cable or a comparable board tester or a simple microprocessor interface.

To allow ISP programming support by the Automated Test Equipment (ATE) vendors, Serial Vector Format (SVF) files can be created by the Atmel JCPS Software. Conversion to other ATE tester format beside SVF is also possible

AT18Fxx devices can also be programmed using standard third-party programmers such as BP, Datal/O, Hi-Lo, etc. Factory-preprogrammed devices, as required by customers, are also available for certain ordering quantities.

Contact your local Atmel representatives or Atmel PLD applications for details.

5.1 JTAG-BST Overview

The JTAG boundary-scan testing is controlled by the Test Access Port (TAP) controller in the AT18F series. The boundary-scan technique involves the inclusion of a shift-register stage (contained in a boundary-scan cell) adjacent to each component so that signals at component boundaries can be controlled and observed using scan testing principles. Each input pin and I/O pin has its own boundary-scan cell (BSC) in order to support boundary-scan testing. The AT18Fxx series does not currently include a Test Reset (TRST) input pin because the TAP controller is automatically reset at power-up. The six JTAG BST modes supported include: SAMPLE/PRELOAD, EXTEST, BYPASS and IDCODE. BST on the AT18Fxx series is implemented using the Boundary-scan Definition Language (BSDL) described in the JTAG specification (IEEE Standard 1149.1). Any third-party tool that supports the BSDL format can be used to perform BST on the AT18Fxx series.

The AT18F series uses the four JTAG-standard I/O pins for In-System programming (ISP). The AT18F series is programmable through the four JTAG pins using programming algorithm compatible with the IEEE JTAG Standard 1532. Programming is performed by using selectable voltage levels of the programming signals from the JTAG ISP interface.

5.2 JTAG Boundary-scan Cell (BSC) Testing

The AT18F series has I/Os that contain boundary-scan cells (BSC) in order to support boundary-scan testing as described in detail by IEEE Standard 1149.1. Input to the capture register chain is fed in from the TDI pin while the output is directed to the TDO pin. Capture registers are used to capture active device data signals, to shift data in and out of the device and to load data into the update registers. Control signals are generated internally by the JTAG TAP controller.





6. Pin Description

Table 6-1.Pin Descriptions		
Name	Туре	20-lead TSSOP
DATA	I/O	1
CLK	I	3
RESET/OE	I	8
CE	I	10
CF	I	7
CEO	0	13
TMS	I	5
ТСК	I	6
TDI	I	4
TDO	0	17
VCCINT	I	18
NC	-	2, 9, 12, 14, 15, 16
VCCO	Power Supply	19
GND	Ground	11
VCCJ	Power Supply	20

6.1 DATA (D0)

Open-collector bi-directional data pin. This pin has an internal 20 K Ω pull-up resistor.

6.2 CLK

Clock input. Used to increment the internal address and bit counter for reading and programming. This pin has an internal 20 K Ω pull-up resistor.

6.3 RESET/OE

Output Enable (active High) and $\overline{\text{RESET}}$ (active Low). A Low level on $\overline{\text{RESET}}$ /OE resets both the address and bit counters. A High level (with $\overline{\text{CE}}$ Low) enables the data output driver. This pin has an internal 20 K Ω pull-up resistor.

6.4 <u>CE</u>

Chip Enable input (active Low). A Low level (with OE High) allows CLK to increment the address counter and enables the data output driver. A High level on \overline{CE} disables both the address and bit counters and forces the device into a low-power standby mode. This pin has an internal 20 K Ω pull-up resistor.

6.5 CF

Configuration Pulse (open-drain output). Allows JTAG CONFIG instruction to initiate FPGA configuration without powering down the FPGA. This is an open-drain output that is pulsed Low by the JTAG CONFIG command.

6 AT18F010/002/040/080 [Preliminary]

6.6	CEO	Chip Enable Output for configuration download. This output goes Low when the internal address counter of the device has reached its maximum value which signals that all configuration data is being clocked out of the device. In a daisy chain of AT18F Series devices, the \overline{CEO} pin of one device must be connected to the \overline{CE} input of the next device in the chain. It will stay Low as long as \overline{CE} is Low and OE is High. It will then follow \overline{CE} until OE goes Low; thereafter, \overline{CEO} will stay High until the entire memory device is read again.
6.7	TMS	JTAG Mode Control Input. The state of TMS with the rising edge of TCK determines the state transitions of the Test Access Port (TAP) controller. TMS has an internal 50 K Ω weak pull-up to V _{CCJ} to provide a logic 1 to the device.
6.8	тск	JTAG Clock Input. This pin is the JTAG clock input to the TAP controller of the device.
6.9	TDI	JTAG Serial Data Input. This pin is the serial input to all JTAG instructions and data registers. An internal 50 K Ω weak pull-up to V _{CCJ} provides a logic 1 to the device.
6.10	TDO	JTAG Serial Data Output. This pin is the serial output to all JTAG instruction and data registers. An internal 50 K Ω weak pull-up to V _{CCJ} provides a logic 1 to the device if the pin is not driven.
6.11	VCCINT	+3.3V supply voltage for internal logic.
6.12	NC	No Connect Pin. This pin is not connected to any internal logic of the device and can be left floating.
6.13	VCCO	Supply voltage for I/O drivers (1.8V, 3.3V, or 3.3V).
6.14	VCCJ	Supply voltage for JTAG I/O drivers (1.8V, 3.3V, or 3.3V).
6.15	GND	Power supply ground.

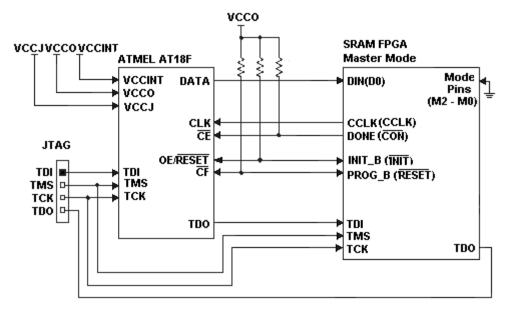
7. Standby Mode

The AT18F Series Configurators enter a low-power standby mode whenever the JTAG mode is inactive and \overline{CE} is asserted High. In this mode, the AT18F Configurator consumes less than 1 mA of current at 3.3V. The output remains in a high-impedance state regardless of the state of the OE input.



8. Configuration Memory to FPGA Device Interface Connection Diagrams

Figure 8-1. General Connection Diagram for Loading FPGA from Configurator and JTAG Signals



- Notes: 1. Signals within parenthesis will be applied to Atmel AT40AK FPGA.
 - 2. For details of the circuit connection, please contact factory.

9. Absolute Maximum Ratings*

Operating Temperature55°C to +125°C
Storage Temperature
Voltage on Any Pin with Respect to Ground0.1V to V_{CC} +0.5V
Supply Voltage (V $_{\rm CC}$)0.5V to +3.6V
Maximum Soldering Temp. (10 sec. @ 1/16 in.)
ESD (R _{ZAP} = 1.5K, C _{ZAP} = 100 pF)

*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

10. Operating Conditions

 $T_{AI} = -40^{\circ} \text{ C}$ to $+85^{\circ} \text{ C}$ for Industrial and 0° C to $+70^{\circ} \text{ C}$ for Commercial

Symbol	Description		Min	Тур	Max	Units
V _{CCINT}	Supply Voltage for Internal Logic		3.0	3.3	3.6	V
		3.3V Operation	3.0	3.3	3.6	
V_{CCO}	V _{CCO} Supply Voltage for I/O Drivers	2.5V Operation	2.3	2.5	2.7	V
		1.8V Operation	1.7	1.8	1.9	
	V _{CCJ} Supply Voltage for JTAG I/O Drivers	3.3V Operation	3.0	3.3	3.6	
V_{CCJ}		2.5V Operation	2.3	2.5	2.7	V
		1.8V Operation	1.7	1.8	1.9	
		3.3V Operation	-0.3		0.8	
V _{IL}	Input Low Voltage	2.5V Operation	-0.3		0.7	V
		1.8V Operation	-0.3		$0.35 \times V_{CCO}$	
		3.3V Operation	2.0		3.9	
V _{IH} In	Input High Voltage	2.5V Operation	1.7		3.9	V
	1.8V Operation		$0.65 \times V_{CCO}$		3.9	1





11. DC Characteristics

Symbol	Description		Condition	Min	Тур	Max	Units
I _{CCINT}	Internal Voltage Supply Current, Active Mode		33 MHz			10	mA
I _{CCIO}	I/O Drive Supply Current	t, Active Mode	33 MHz			10	mA
I _{CCJ}	JTAG Supply Current, A	ctive Mode				5	mA
I _{CCINTS}	Internal Voltage Supply Current, Standby Mode		$V_{CCINT} = 3.6V,$ $V_{CIO} = 3.6V$			1	mA
I _{CCIOS}	Output Drive Supply Cu	rrent, Standby Mode	$V_{CCINT} = 3.6V,$ $V_{CIO} = 3.6V$			1	mA
I _{CCJS}	JTAG Supply Current, Standby Mode		$V_{CCINT} = 3.6V,$ $V_{CIO} = 3.6V$			1	mA
I _{IL}	Input or I/O Low Leakage				1	10	μA
I _{IH}	Input or I/O High Leakag	je		-10	10	10	μA
		3.3V Operation				0.4	
V _{OL}	Output Low Voltage	2.5V Operation				0.4	V
		1.8V Operation				0.45	
		3.3V Operation		V _{CCO} - 0.4			
V _{OH}	Output High Voltage	2.5V Operation		V _{CCO} - 0.4			V
		1.8V Operation		V _{CCO} - 0.45			1

12. AC Characteristics

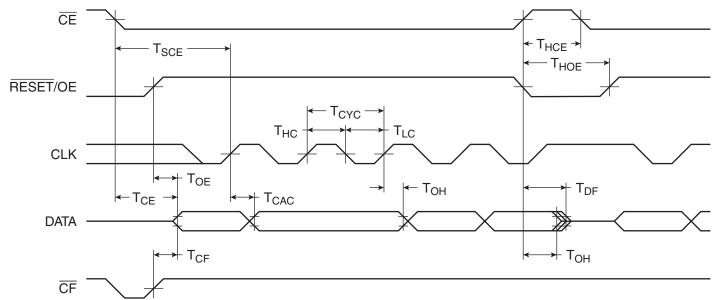


Figure 12-1. AT18Fxx as Configuration Slave with CLK Input Pin as Clock Source

Table 12-1.	AC Characteristics over Operating Conditions

Symbol	Description	Min	Max	Units
T _{CF}	CF to Data Delay	20	50	μs
T _{OE}	RESET/OE to Data Delay		10	ns
T _{CE}	CE to Data Delay	20		μs
T _{CAC}	CLK to Data Delay		15	ns
Т _{ОН}	Data Hold from \overline{CE} , \overline{RESET}/OE , CLK, or \overline{CF}		15	ns
T _{DF}	CE or RESET/OE to Data Float Delay		25	ns
T _{CYC}	Clock Period	30		ns
T _{LC}	CLK Low Time	15		ns
T _{HC}	CLK High Time	15		ns
T _{SCE}	CE Setup Time to CLK	20		μs
T _{HCE}	CE Hold Time	250		ns
T _{HOE}	RESET/OE Hold Time	250		ns
T _{BLKE}	Block Erase Time	0.7	1	S
	Bulk Erase Time – 1M		3	S
Ŧ	Bulk Erase Time – 2M		5	S
T _{ERASE}	Bulk Erase Time – 4M		9	S
	Bulk Erase Time – 8M		15	S
Т _{СК_J}	TAP Clock Minimum Period	100		ns





Figure 12-2. AC Characteristics when Cascading

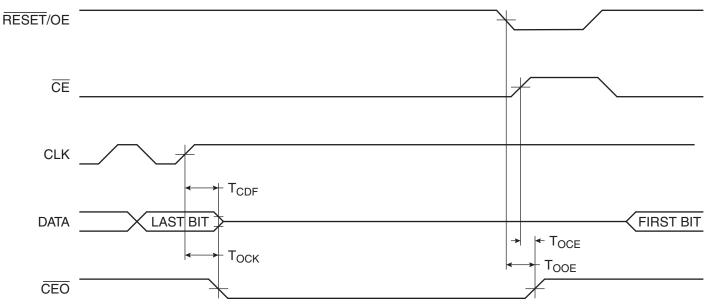


Table 12-2. AC Characteristics When Cascading

Symbol	Description Min		Max	Units
T _{CDF}	CLK to Output Float Delay		25	ns
Тоск	CLK to CEO Delay		20	ns
T _{OCE}	CE to CEO Delay		20	ns
T _{OOE}	RESET/OE to CEO Delay		20	ns

13. Ordering Information

Memory Size	Ordering Code	Package	Operation Range
1-Mbit	AT18F010-30XU	20A2 - 20 TSSOP	Industrial (-40° C to 85° C)
2-Mbit	AT18F002-30XU	20A2 - 20 TSSOP	Industrial (-40° C to 85° C)
4-Mbit	AT18F040-30XU	20A2 - 20 TSSOP	Industrial (-40° C to 85° C)
7-Mbit	AT18F080-30XU	20A2 - 20 TSSOP	Industrial (-40° C to 85° C)

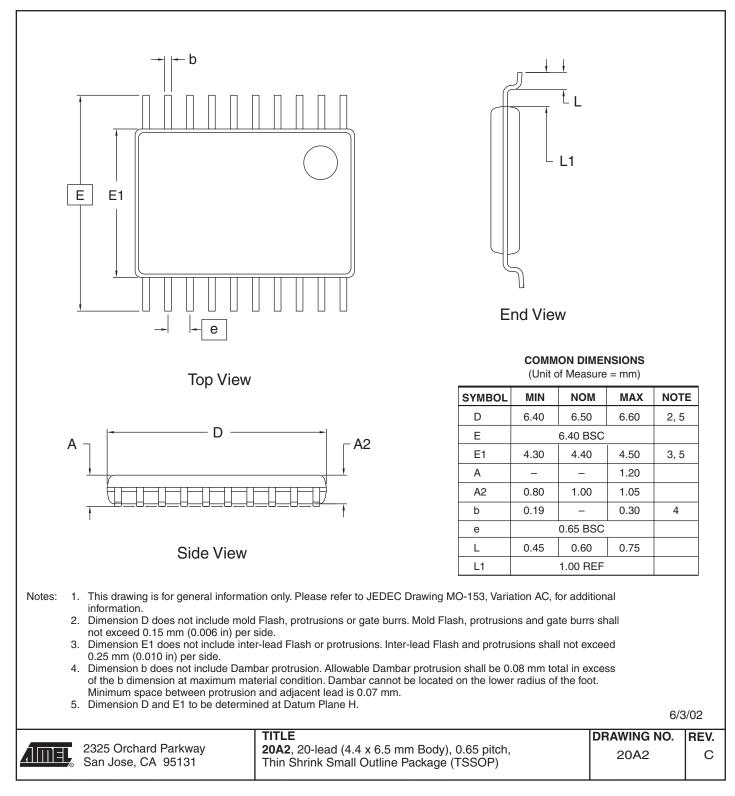
Package Type			
20A2	20-lead, 0.65 mm Wide, Plastic Think-Shrink Small Outline (TSSOP)		





14. Packaging Information

14.1 20A2 - TSSOP



15. Revision History

Revision Level – Release Date	History
A – January 2008	Initial release.





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